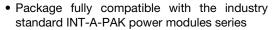


Three Phase Bridge, 130 A to 160 A (Power Modules)



| PRIMARY CHARACTERISTICS | | | |
|-------------------------|--------------------|--|--|
| Io | 130 A to 160 A | | |
| V_{RRM} | 800 V to 1600 V | | |
| Package | MTK | | |
| Circuit configuration | Three phase bridge | | |

FEATURES





- High thermal conductivity package, electrically insulated case
- Excellent power volume ratio
- 4000 V_{RMS} isolating voltage
- UL E78996 approved
- · Designed and qualified for industrial level
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

DESCRIPTION

A range of extremely compact, encapsulated three phase bridge rectifiers offering efficient and reliable operation. They are intended for use in general purpose and heavy duty applications.

| MAJOR RATINGS AND CHARACTERISTICS | | | | | |
|-----------------------------------|-----------------|-------------------|-------------------|-------------------|--|
| SYMBOL | CHARACTERISTICS | VALUES 130MT.K | VALUES 160MT.K | UNITS | |
| | | 130 (160) | 160 (200) | А | |
| l _O | T _C | 85 (62) | 85 (60) | °C | |
| 1 | 50 Hz | 1130 | 1430 | A | |
| I _{FSM} | 60 Hz | 1180 | 1500 | | |
| l ² t | 50 Hz | 6400 | 10 200 | A ² s | |
| 1-1 | 60 Hz | 5800 | 9300 | | |
| I ² √t | | 64 000 | 102 000 | A ² √s | |
| V _{RRM} | Range | 800 to | 1600 | V | |
| T _{Stg} | Panga | -40 to 150 | | °C | |
| TJ | Range | -40 to | 150 | 7 | |

ELECTRICAL SPECIFICATIONS

| VOLTAGE RATINGS | | | | | |
|--------------------------|-----------------|--|--|---|--|
| TYPE NUMBER | VOLTAGE CODE | V _{RRM} , MAXIMUM REPETITIVE PEAK REVERSE VOLTAGE V | V _{RSM} , MAXIMUM NON-REPETITIVE PEAK REVERSE VOLTAGE V | I _{RRM} MAXIMUM AT T _J = MAXIMUM mA | |
| | 80 | 800 | 900 | | |
| VS-130MT.K VS-160MT.K | 100 | 1000 | 1100 | | |
| | 120 | 1200 | 1300 | 10 | |
| | 140 | 1400 | 1500 | | |
| | 160 | 1600 | 1700 | | |





| FORWARD CONDUCTION | | | | | | | |
|---|---------------------|---|------------------------|---------------------|-------------------|---------|------------------|
| PARAMETER | SYMBOL | TEST CONDITIONS | | VALUES 130MT.K | VALUES 160MT.K | UNITS | |
| Maximum DC output current | | 120° rect. conduction angle | | 130 (160) | 160 (200) | Α | |
| at case temperature | I _O | | | le | 85 (62) | 85 (60) | °C |
| | I _{FSM} | t = 10 ms | No voltage | Initial | 1130 | 1430 | А |
| Maximum peak, one-cycle | | t = 8.3 ms | reapplied | | 1180 | 1500 | |
| forward, non-repetitive surge current | | t = 10 ms | 100 % V _{RRM} | | 950 | 1200 | |
| | | t = 8.3 ms | reapplied | | 1000 | 1260 | |
| Maximum I ² t for fusing | l ² t | t = 10 ms | No voltage | $T_J = T_J$ maximum | 6400 | 10 200 | A ² s |
| | | t = 8.3 ms | reapplied | - | 5800 | 9300 | |
| | | t = 10 ms | 100 % V _{RRM} | | 4500 | 7200 | |
| | | t = 8.3 ms | reapplied | | 4100 | 6600 | |
| Maximum I ² √t for fusing | I ² √t | t = 0.1 ms to 10 ms, no voltage reapplied | | 64 000 | 102 000 | A²√s | |
| Low level value of threshold voltage | V _{T(TO)1} | (16.7 % x π x $I_{T(AV)}$ < I < π x $I_{T(AV)}$), I_{J} maximum | | 0.78 | 0.81 | V | |
| High level value of threshold voltage | V _{T(TO)2} | $(I > \pi \times I_{T(AV)})$, T_J maximum | | 0.99 | 1.04 | V | |
| Low level value of forward slope resistance | r _{f1} | 16.7 % x π x I _{T(AV)} < I < π x I _{T(AV)}), T _J maximum | | 4.59 | 3.52 | mΩ | |
| High level of forward slope resistance | r _{f2} | $(I > \pi \times I_{T(AV)})$, T_J maximum | | 4.17 | 3.13 | 11122 | |
| Maximum forward voltage drop | V _{FM} | I_{pk} = 200 A, T_J = 25 °C, t_p = 400 μ s single junction | | 1.63 | 1.49 | V | |
| RMS isolation voltage | V _{ISOL} | T _J = 25 °C, all terminal shorted f = 50 Hz, t = 1 s | | 40 | 00 | | |

| THERMAL AND MECHANICAL SPECIFICATIONS | | | | | |
|--|-----------------------------------|---|-------------------|-------------------|-------|
| PARAMETER SYMBOL | | TEST CONDITIONS | VALUES 130MT.K | VALUES 160MT.K | UNITS |
| Maximum junction operating and storage temperature range | T _J , T _{Stg} | | -40 to | o 150 | °C |
| | R _{thJC} | DC operation per module | 0.16 | 0.12 | K/W |
| Maximum thermal resistance, junction to case | | DC operation per junction | 0.93 | 0.73 | |
| | | 120° rect. conduction angle per module | 0.18 | 0.15 | |
| | | 120° rect. conduction angle per junction | 1.08 | 0.88 | |
| Maximum thermal resistance, case to heatsink | | Per module Mounting surface smooth, flat and greased | 0.03 | | |
| Mounting to heatsink | | A mounting compound is recommended and 4 to 6 | | o 6 | Nm |
| torque ± 10 % to terminal | | the torque should be rechecked after a period of 3 hours to allow for the spread of the | 3 to 4 | | INITI |
| Approximate weight | | compound. Lubricated threads. | 176 | | g |

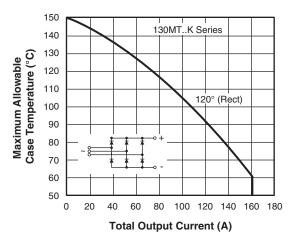
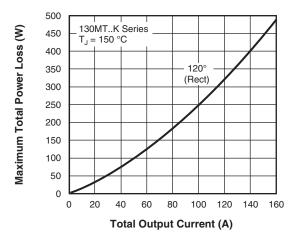


Fig. 1 - Current Rating Characteristics



Peak Half Sine Wave Forward Current (A) 600 500 400 300 130MT..K Series

1000

900

800

700

Half Cycle Current Pulses (N) Fig. 4 - Maximum Non-Repetitive Surge Current

Number of Equal Amplitude

At any rated load condition and with

rated V_{RRM} applied following surge

Initial $T_J = 150^{\circ}C$

at 60 Hz 0.0083 s

at 50 Hz 0.0100 s

100

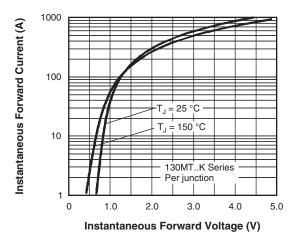


Fig. 2 - Forward Voltage Drop Characteristics

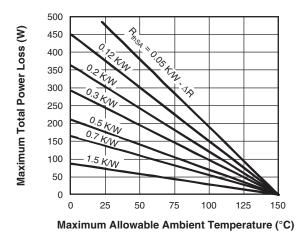


Fig. 3 - Total Power Loss Characteristics

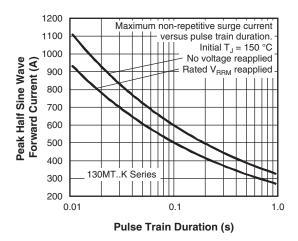


Fig. 5 - Maximum Non-Repetitive Surge Current

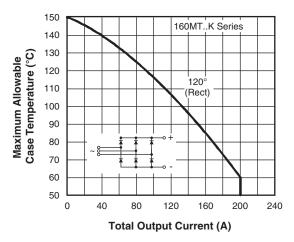
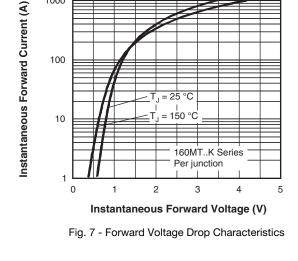


Fig. 6 - Current Ratings Characteristic



1000

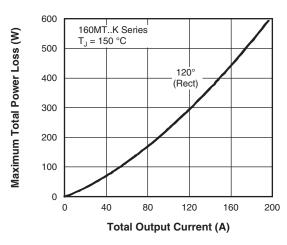
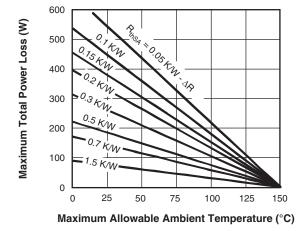


Fig. 8 - Total Power Loss Characteristics



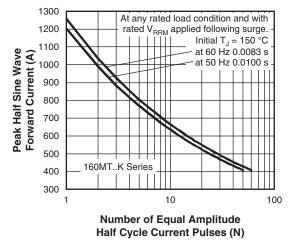


Fig. 9 - Maximum Non-Repetitive Surge Current

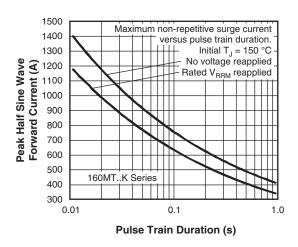


Fig. 10 - Maximum Non-Repetitive Surge Current

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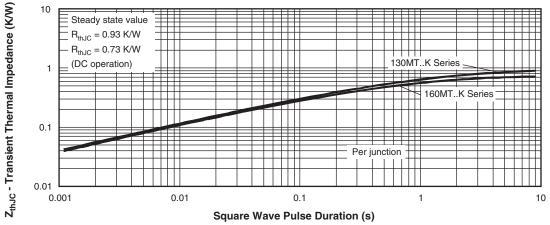
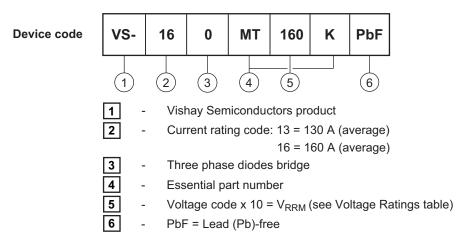


Fig. 11 - Thermal Impedance ZthJC Characteristics

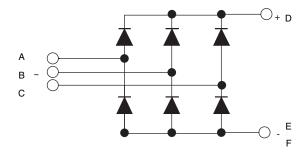
ORDERING INFORMATION TABLE



Note

• To order the optional hardware go to: www.vishay.com/doc?95172

CIRCUIT CONFIGURATION

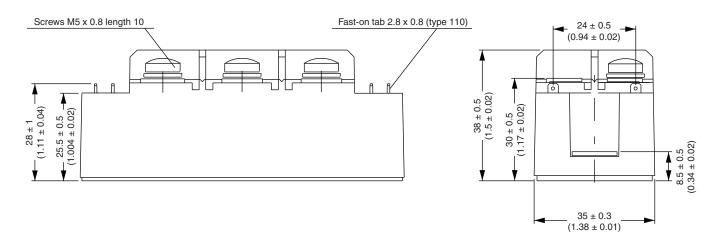


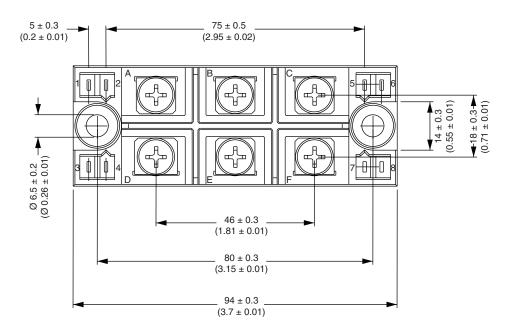
| LINKS TO RELATED DOCUMENTS | | | |
|----------------------------|--------------------------|--|--|
| Dimensions | www.vishay.com/doc?95004 | | |



MTK (with and without optional barrier)

DIMENSIONS WITH OPTIONAL BARRIERS in millimeters (inches)

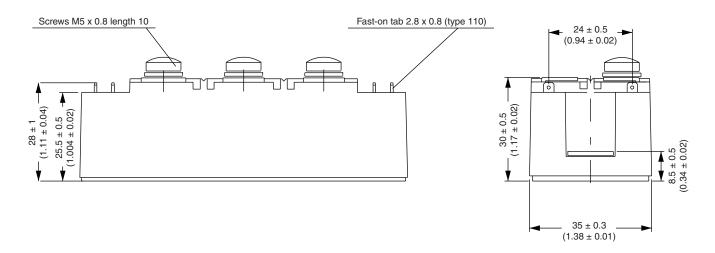


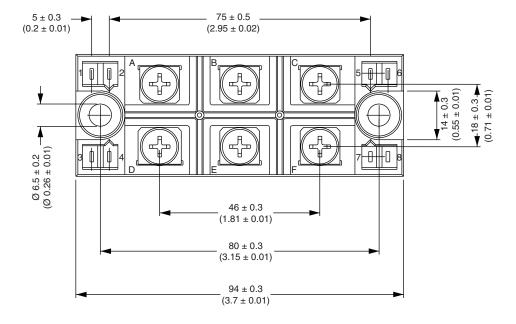


Vishay Semiconductors MTK (with and without optional barrier)



DIMENSIONS WITHOUT OPTIONAL BARRIERS in millimeters (inches)







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